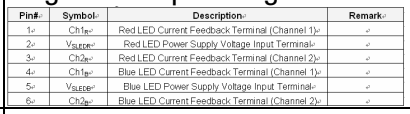
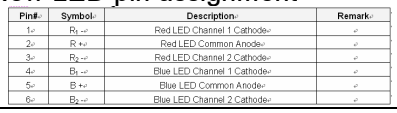
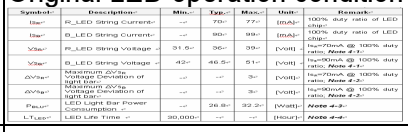
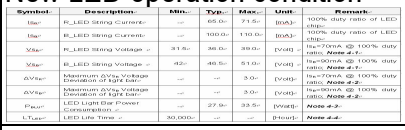
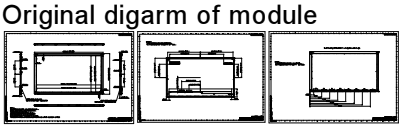
(V) Preliminary Specification
( ) Final Specification

Module	**27.0” Color TFT-LCD**
Model Name	**M270DAN01.1**

Customer	**Date**	**Approved by**	**Date**
		Howard Lee	Jan 10, 2013
Approved by		**Prepared by**	**Date**
		ShinYu Lin	Mar 20, 2013
Note: This Specification is subject to change without notice.		AU Optronics corporation	

Contents

Record of Revision

Version	Date	Page	Old description	New Description	Remark
0.0	2012/12/26	All	First version release	-	
0.1	2013/1/24	27	Original LED block diagarm	New LED block diagarm	
		30	Original LED pin assignment 	New LED pin assignment 	
0.2	2013/3/20	6	1. The original power consumption of module is 26.8W 2. The original weight of panel is TBD.	1. The new power consumption of module is 27.9W 2. The original weight of panel is 3050g.	
		8	Original R/G/ B chromaticity	New R/G/ B chromaticity	
		8/31	The original IS_R and IS_B of test condition are 70mA and 90mA respectively	The new IS_R and IS_B of test condition are 65mA and 100mA respectively	
		11	The original measurement pattern of cross talk is black with gray level 127.	The new measurement pattern of cross talk is black with gray level 511.	
		14	Original PCBA input connector information	New PCBA input connector information	
		30	Original LED operation condition 	New LED operation condition 	
		33~35	Original digarm of module 	New digarm of module 	
		37	Original pallet and shipment information 1. The wight of panel is TBD. 2. The weight of cushion is 4.41kg. 3. The wight of box is 1.35kg. 4. The weight of packing box is TBD. 5. The weight of pallet after packing is TBD.	New pallet and shipment information 1. The wight of panel is 3.05kg 2. The weight of cushion is 3.62kg 3. The wight of box is 1.25kg 4. The weight of packing box is 29.27kg 5. The weight of packing box is 247.06kg	
		14~16 / 18~19 / 23	1. The original relationship between LVDS 4 ports input signal is dual screen. 2. The original naming of input signal are RFO_XX/ RBO_XX/ RFE_XX/ RBE_XX 3. The original naming of signal pair	1. The new relationship between LVDS 4 ports input signal is single screen 2. The new naming of input signal are RX_XX/ RX_XX 3. The new naming of signal pair are port 1/ port 2/ port 3/ port	

			are RFO/ RFE/ RBO/ RBE	4	
		32	The height of drop test condition is 60 cm	The height of drop test condition is 45.6 cm	

1 Handling Precautions

1) Since front polarizer is easily damaged, pay attention not to scratch it.
2) Be sure to turn off power supply when inserting or disconnecting from input connector.
3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
7) Do not open or modify the Module Assembly.
8) Do not press the reflector sheet at the back of the module to any directions.
9) In case a TFT-LCD Module has to be put back into the packing container slot after once it was taken out from the container, do not press the center of the LED lightbar edge. Otherwise the TFT-LCD Module may be damaged.
10) Insert or pull out the interface connector, be sure not to rotate nor tilt it of the TFT-LCD Module.
11) Do not twist nor bend the TFT -LCD Module even momentary. It should be taken into consideration that no bending/twisting forces are applied to the TFT-LCD Module from outside. Otherwise the TFT-LCD Module may be damaged.
12) Please avoid touching COF position while you are doing mechanical design.
13) When storing modules as spares for a long time, the following precaution is necessary:
Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5℃ and 35℃ at normal humidity.

2 General Description

This specification applies to the 27.0 inch wide Color a-Si TFT-LCD Module M270DAN01.1. The display supports the WQHD - 2560(H) x 1440(V) screen format and 1.07B colors (RGB 10-bits). The input interface is 4 channel LVDS and this module doesn't contain an driver board for backlight.

2.1 Display Characteristics

The following items are characteristics summary on the table under 25℃ condition:

ITEMS	Unit	SPECIFICATIONS
Screen Diagonal	[mm]	684.7 (27.0")
Active Area	[mm]	596.7 (H) x 335.6 (V)
Pixels H x V	-	2560(x3) x 1440
Pixel Pitch	[um]	233.1 (per one triad) ×233.1
Pixel Arrangement	-	R.G.B. Vertical Stripe
Display Mode	-	Normally Black
White Luminance (Center)	[cd/m^2]	350 cd/m2 (Typ.)
Contrast Ratio	-	1000 (Typ.)
Response Time	[msec]	12ms (Typ., G/G)
Power Consumption (LCD Module + Backligh unit)	[Watt]	35.9 (Typ.) LCD module : PDD (Typ.)=8 W @ white pattern,Fv=60Hz Backlight unit : P_{BLU} (Typ.) =27.9W @ Is_R=65mA and Is_B=100mA
Weight	[Grams]	3050g
Outline Dimension	[mm]	630(H) × 368.2(V) × 12.45(D) Typ.
Electrical Interface	-	4 channel LVDS
Support Color	-	1.07B colors (RGB 10-bit)
Surface Treatment	-	Anti-Glare, 3H
Temperature Range Operating Storage (Shipping)	 [°C] [°C]	 0 to +50 -20 to +60
RoHS Compliance	-	RoHS Compliance
TCO Compliance	-	TCO 6.0 Compliance

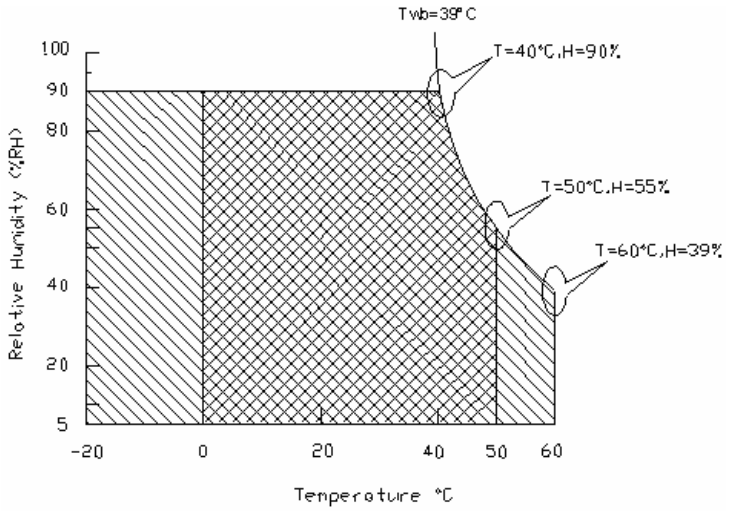
2.2 Absolute Maximum Rating of Environment

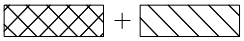
Permanent damage may occur if exceeding the following maximum rating.

Symbol	Description	Min.	Max.	Unit	Remark
TOP	Operating Temperature	0	+50	[°C]	***Note 2-1***
TGS	Glass surface temperature (operation)	0	+65	[°C]	***Note 2-1*** *Function judged only*
HOP	Operation Humidity	5	90	[%RH]	***Note 2-1***
TST	Storage Temperature	-20	+60	[°C]	
HST	Storage Humidity	5	90	[%RH]	

Note 2-1: Temperature and relative humidity range are shown as the below figure.

1. 90% RH Max (Ta ≦39℃)
2. Max wet-bulb temperature at 39℃ or less. (Ta ≦39℃)
3. No condensation



Operating Range  Storage Range 

2.3 Optical Characteristics

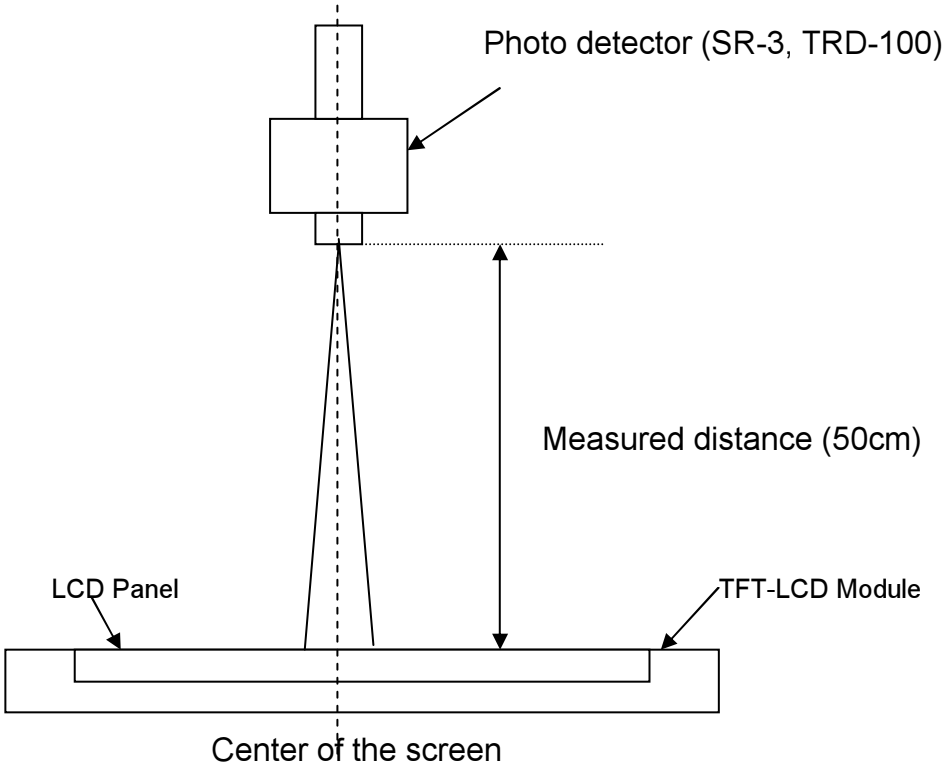
The optical characteristics are measured on the following test condition.

Test Condition:

1. Equipment setup: Please refer to ***Note 2-2***.
2. Panel Lighting time: 30 minutes
3. VDD=5.0V, Fv=60Hz, ,Is_R=65mA, Is_B=100mA Ta=25℃

Symbol	Description		Min.	Typ.	Max.	Unit	Remark
L_w	White Luminance (Center of screen)		280	350	-	[cd/㎡]	***Note 2-2*** *By SR-3*
L_{uni}	Luminance Uniformity (9 points)		75	80	-	[%]	***Note 2-3*** *By SR-3*
CR	Contrast Ratio (Center of screen)		600	1000	-	-	***Note 2-4*** *By SR-3*
θ_R	Horizontal Viewing Angle (CR=10)	Right	75	89	-	[degree]	***Note 2-5*** *By SR-3*
θ_L		Left	75	89	-		
Φ_H	Vertical Viewing Angle (CR=10)	Up	75	89	-		
Φ_L		Down	75	89	-		
θ_R	Horizontal Viewing Angle (CR=5)	Right	75	89	-		
θ_L		Left	75	89	-		
Φ_H	Vertical Viewing Angle (CR=5)	Up	75	89	-		
Φ_L		Down	75	89	-		
-	Response Time (Gray to Gray)	Rising + Falling	-	12	-	[msec]	***Note 2-6*** *By TRD-100*
R_x	Color Coordinates (CIE 1931)	Red x	0.659	0.689	0.719	-	*By SR-3*
R_y		Red y	0.269	0.299	0.329		
G_x		Green x	0.178	0.208	0.238		
G_y		Green y	0.684	0.714	0.744		
B_x		Blue x	0.119	0.149	0.179		
B_y		Blue y	0.020	0.050	0.080		
W_x		White x	0.283	0.313	0.343		
W_y		White y	0.299	0.329	0.359		
CT	Crosstalk		-	-	-	1.5	***Note 2-7*** *By SR-3*
F_{dB}	Flicker (Center of screen)		-	-	-20	[dB]	***Note 2-8*** *By SR-3*

Note 2-2: Equipment setup :

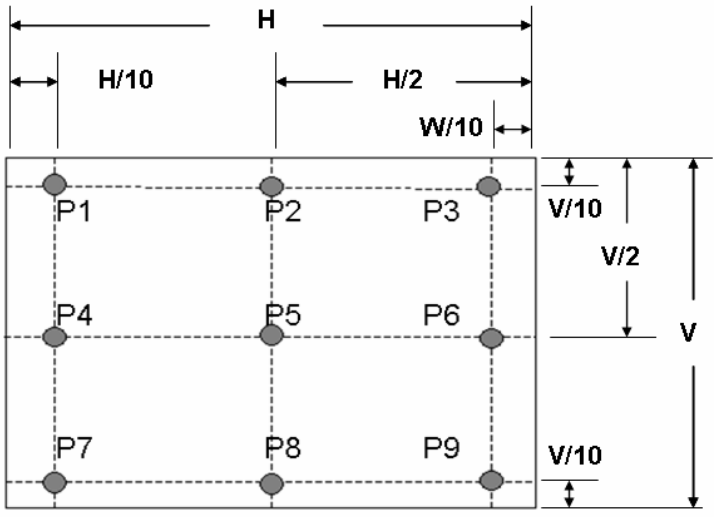


Note 2-3: Luminance Uniformity Measurement

Definition:

$$\text{Luminance Uniformity} = \frac{\text{Minimum Luminance of 9 Points (P1 ~ P9)}}{\text{Maximum Luminance of 9 Points (P1 ~ P9)}}$$

a. Test pattern: White Pattern



Note 2-4: Contrast Ratio Measurement

Definition:

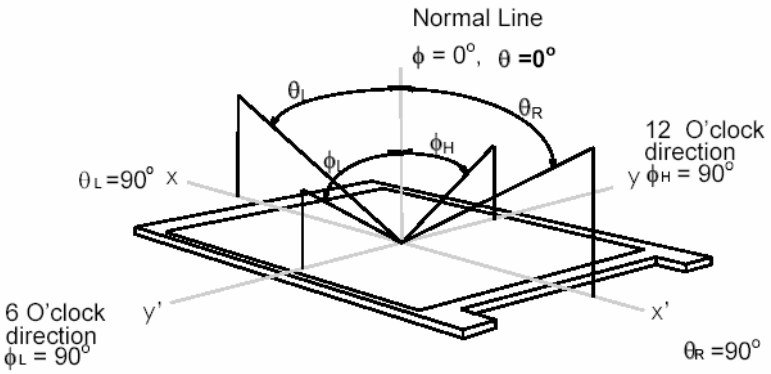
$$\text{Contrast Ratio} = \frac{\text{Luminance of White pattern}}{\text{Luminance of Black pattern}}$$

a. Measured position: Center of screen (P5) & perpendicular to the screen (θ=Φ=0°)

Note 2-5: Viewing angle measurement

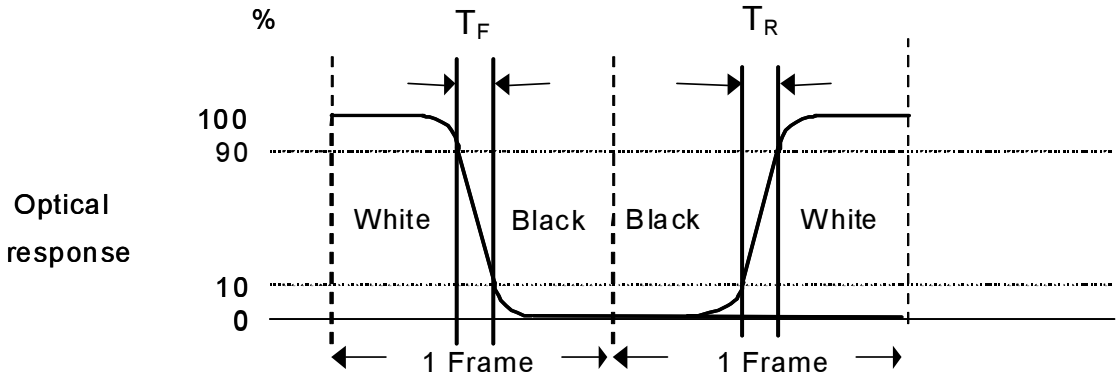
Definition: The angle at which the contrast ratio is greater than 10 & 5 .

a. Horizontal view angle: Divide to left & right (θ_L & θ_R)
Vertical view angle: Divide to up & down (Φ_H &Φ_L)



Note 2-6: Response time measurement

The output signals of photo detector are measured when the input signals are changed from "Black" to "White" (rising time, T_R), and from "White" to "Black" (falling time, T_F), respectively. The response time is interval between the 10% and 90% of optical response. (*Black & White color definition: Please refer section 3.4.3)*



The gray to gray response time is defined as the following table. The algorithm is | Gray Level A – Gray Level B | ≧256.

Gray Level to Gray Level		Falling Time				
		G0	G255	G511	G767	G1023
Rising Time	G0					
	G255					
	G511					
	G767					
	G1023					

- T_{GTG_typ} is the total average time at rising time and falling time of gray to gray.
- T_{GTG_max} is the maximum time at rising time or falling time of gray to gray.

Note 2-7: Crosstalk measurement

Definition:

$CT = Max. (CT_H, CT_V)$;

Where

a. Maximum Horizontal Crosstalk :

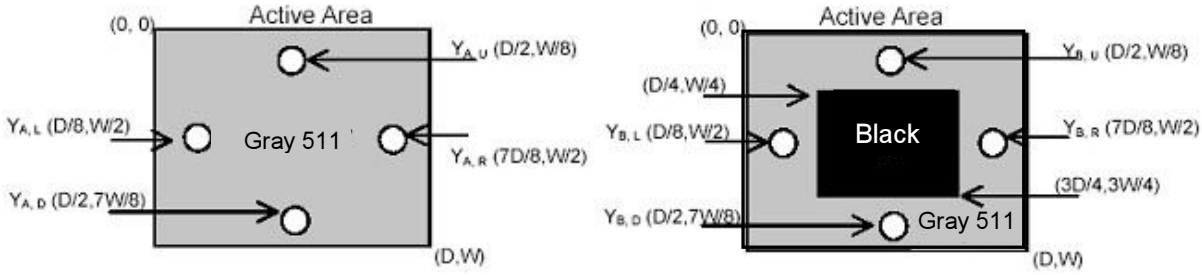
$CT_H = Max. (| Y_{BL} – Y_{AL} | / Y_{AL} \times 100\ \%, | Y_{BR} – Y_{AR} | / Y_{AR} \times 100\ \%)$;

Maximum Vertical Crosstalk:

$CT_V = Max. (| Y_{BU} – Y_{AU} | / Y_{AU} \times 100\ \%, | Y_{BD} – Y_{AD} | / Y_{AD} \times 100\ \%)$;

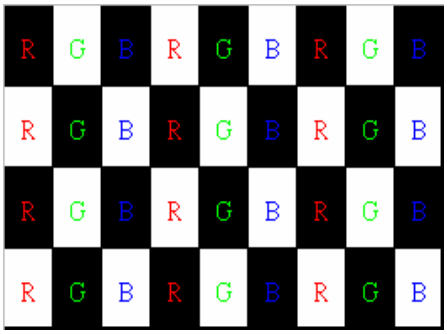
b. Y_{AU}, Y_{AD}, Y_{AL}, Y_{AR} = Luminance of measured location without Black pattern

Y_{BU}, Y_{BD}, Y_{BL}, Y_{BR} = Luminance of measured location with Black pattern



Note 2-8: Flicker measurement

a. Test pattern: It is listed as following.



Gray level = L0

Gray level = L511

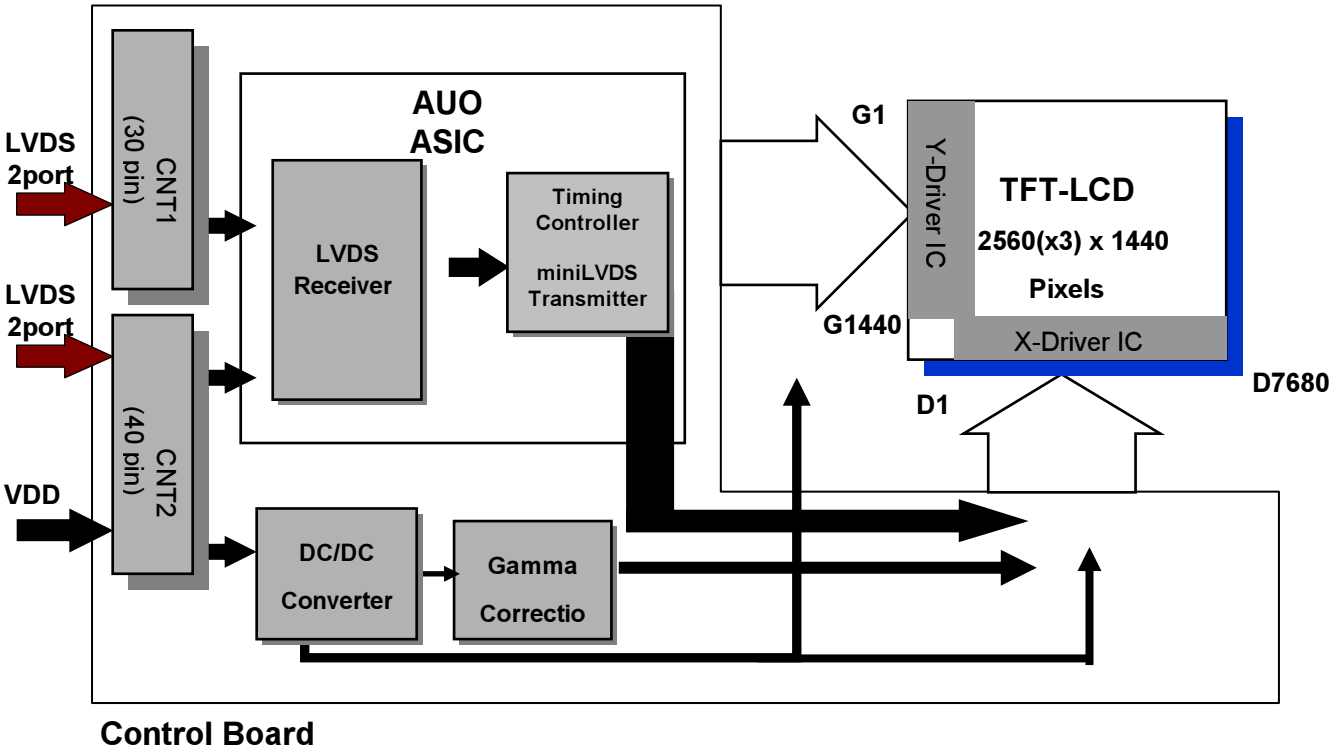
R: Red, G: Green, B:Blue

b. Measured position: Center of screen (P5) & perpendicular to the screen (θ=Φ=0°)

3 TFT-LCD Module

3.1 Block Diagram

The following shows the block diagram of the 27.0 inch Color TFT-LCD Module.



3.2 Interface Connection

3.2.1 Connector Type

TFT-LCD Connector (CNT1)	Manufacturer	STM	P-TOW	STARCONN
	Part Number	MSCKT2407P30HB	AL230F-A0G1D-P	093G30-02001A-M4
TFT-LCD Connector (CNT2)	Manufacturer	STARCONN	-	-
	Part Number	115F40-R000RA-M3	-	-
Mating Connector (CNT1)	Manufacturer	JAE	STM	-
	Part Number	FI-X30HL (Locked Type)	PK2407P30V	-
Mating Connector (CNT2)	Manufacturer	JAE		-
	Part Number	FI-NX40HL		-

3.2.2 Connector Pin Assignment

Module Connector - CNT1

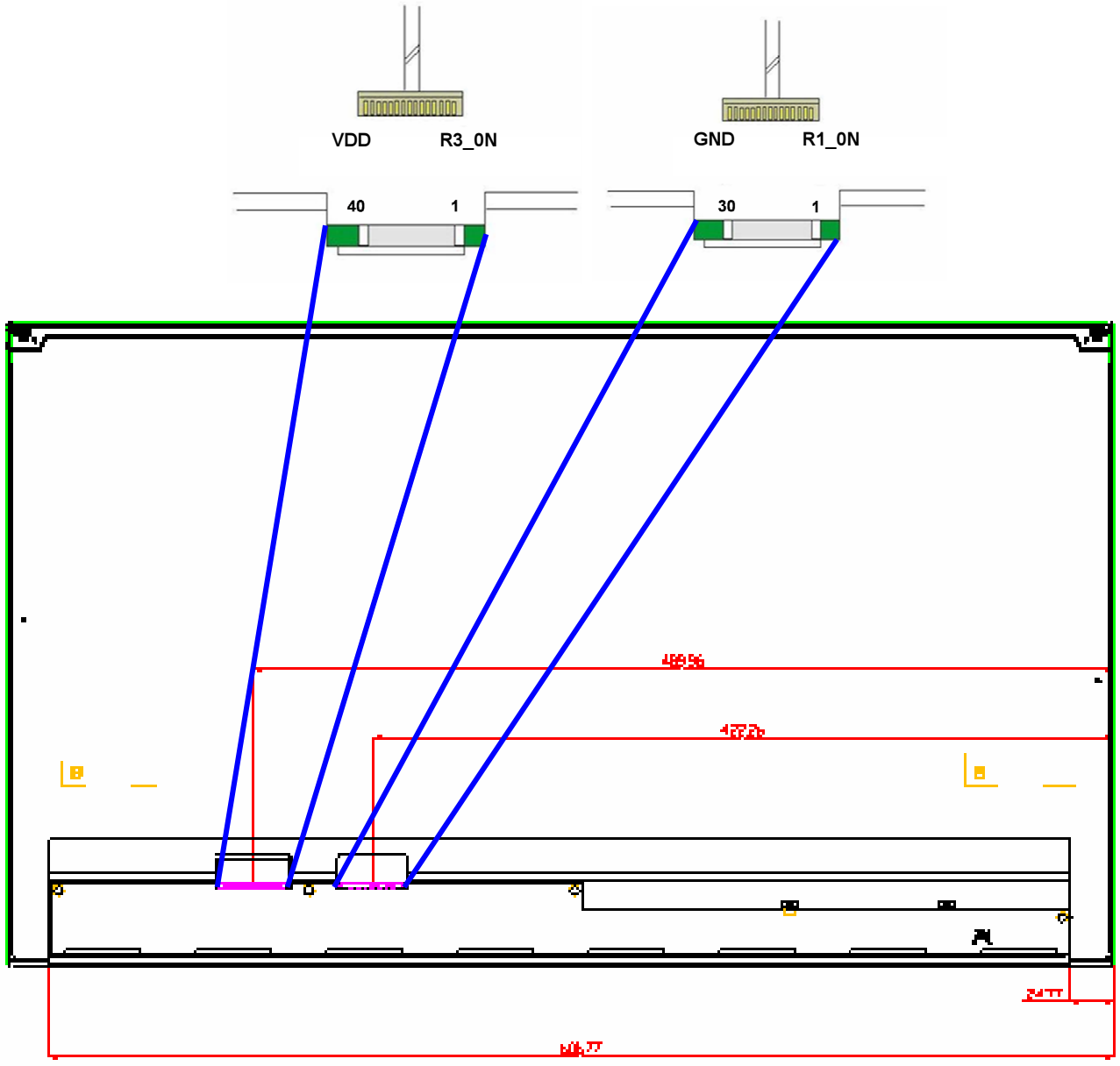
PIN #	Signal Name	Description	Function
1	R1_0N	FIRST_ Negative LVDS differential data input	LVDS port 1
2	R1_0P	FIRST_ Positive LVDS differential data input	
3	R1_1N	FIRST_ Negative LVDS differential data input	
4	R1_1P	FIRST_ Positive LVDS differential data input	
5	R1_2N	FIRST_ Negative LVDS differential data input	
6	R1_2P	FIRST_ Positive LVDS differential data input	
7	GND	Power Ground	
8	R1_CLKN	FIRST_ Negative LVDS differential clock input	
9	R1_CLKP	FIRST_ Positive LVDS differential clock input	
10	GND	Power Ground	
11	R1_3N	FIRST_ Negative LVDS differential data input	
12	R1_3P	FIRST_ Positive LVDS differential data input	
13	R1_4N	FIRST_ Negative LVDS differential data input	
14	R1_4P	FIRST_ Positive LVDS differential data input	
15	GND	Power Ground	
16	R2_0N	SECOND_ Negative LVDS differential data input	LVDS port 2
17	R2_0P	SECOND_ Positive LVDS differential data input	
18	R2_1N	SECOND_ Negative LVDS differential data input	
19	R2_1P	SECOND_ Positive LVDS differential data input	
20	R2_2N	SECOND_ Negative LVDS differential data input	
21	R2_2P	SECOND_ Positive LVDS differential data input	

22	GND	Power Ground	
23	R2_CLKN	SECOND_ Negative LVDS differential clock input	
24	R2_CLKP	SECOND_ Positive LVDS differential clock input	
25	GND	Power Ground	
26	R2_3N	SECOND_ Negative LVDS differential data input	
27	R2_3P	SECOND_ Positive LVDS differential data input	
28	R2_4N	SECOND_ Negative LVDS differential data input	
29	R2_4P	SECOND_ Positive LVDS differential data input	
30	GND	Power Ground	

Module Connector - CNT2

PIN #	Signal Name	Description	Function
1	R3_0N	THIRD_ Negative LVDS differential data input	LVDS port 3
2	R3_0P	THIRD_ Positive LVDS differential data input	
3	R3_1N	THIRD_ Negative LVDS differential data input	
4	R3_1P	THIRD_ Positive LVDS differential data input	
5	R3_2N	THIRD_ Negative LVDS differential data input	
6	R3_2P	THIRD_ Positive LVDS differential data input	
7	GND	Power Ground	
8	R3_CLKN	THIRD_ Negative LVDS differential clock input	
9	R3_CLKP	THIRD_ Positive LVDS differential clock input	
10	GND	Power Ground	
11	R3_3N	THIRD_ Negative LVDS differential data input	
12	R3_3P	THIRD_ Positive LVDS differential data input	
13	R3_4N	THIRD_ Negative LVDS differential data input	
14	R3_4P	THIRD_ Positive LVDS differential data input	
15	GND	Power Ground	
16	R4_0N	FOURTH_ Negative LVDS differential data input	LVDS port 4
17	R4_0P	FOURTH_ Positive LVDS differential data input	
18	R4_1N	FOURTH_ Negative LVDS differential data input	
19	R4_1P	FOURTH_ Positive LVDS differential data input	
20	R4_2N	FOURTH_ Negative LVDS differential data input	
21	R4_2P	FOURTH_ Positive LVDS differential data input	
22	GND	Power Ground	
23	R4_CLKN	FOURTH_ Negative LVDS differential clock input	
24	R4_CLKP	FOURTH_ Positive LVDS differential clock input	
25	GND	Power Ground	
26	R4_3N	FOURTH_ Negative LVDS differential data input	
27	R4_3P	FOURTH_ Positive LVDS differential data input	
28	R4_4N	FOURTH_ Negative LVDS differential data input	
29	R4_4P	FOURTH_ Positive LVDS differential data input	
30	GND	Power Ground	

31	NC	No connection (for AUO test only. Do not connect)	NC
32	NC	No connection (for AUO test only. Do not connect)	
33	GND	Power Ground	Power
34	GND	Power Ground	
35	GND	Power Ground	
36	VDD	Power +5V	
37	VDD	Power +5V	
38	VDD	Power +5V	
39	VDD	Power +5V	
40	VDD	Power +5V	



3.3 Electrical Characteristics

3.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

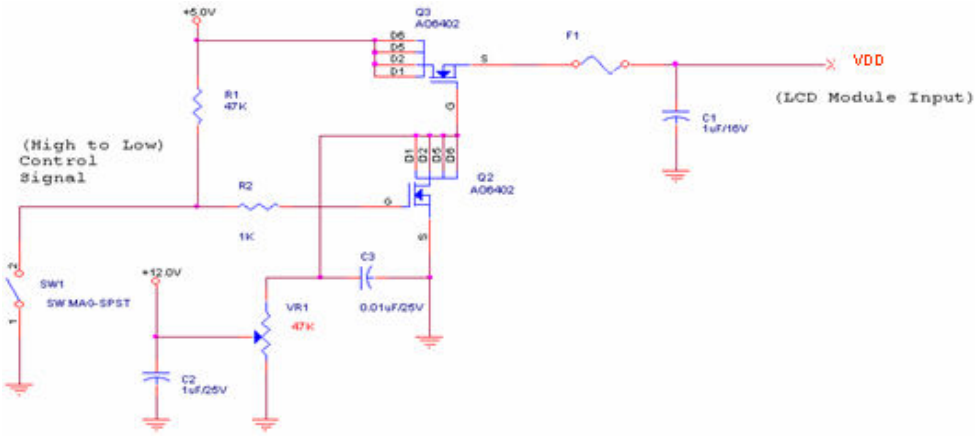
Symbol	Description	Min	Max	Unit	Remark
VDD	Power Supply Input Voltage	GND-0.3	6.0	[Volt]	Ta=25℃

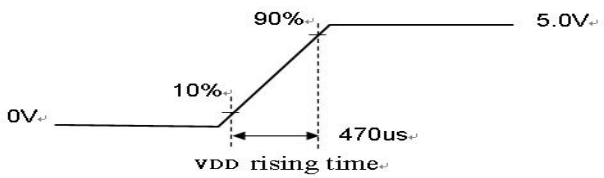
3.3.2 Recommended Operating Condition

Symbol	Description	Min	Typ	Max	Unit	Remark
VDD	Power supply Input voltage	4.5	5.0	5.5	[Volt]	
IDD	Power supply Input Current (RMS)	-	1.6	2.0	[A]	VDD= 5.0V, Black Pattern, Fv=60Hz
			2.0	2.5	[A]	VDD= 5.0V, Black Pattern, Fv=75Hz
PDD	VDD Power Consumption	-	8.0	10.0	[Watt]	VDD= 5.0V, Black Pattern, Fv=60Hz
			10.0	12.5	[Watt]	VDD= 5.0V, Black Pattern, Fv=75Hz
IRush	Inrush Current	-	-	2.0	[A]	***Note 3-1***
VDDrp	Allowable VDD Ripple Voltage	-	-	500	[mV]	VDD= 5.0V, Black Pattern, Fv=75Hz

Note 3-1: Inrush Current measurement:

Test circuit:



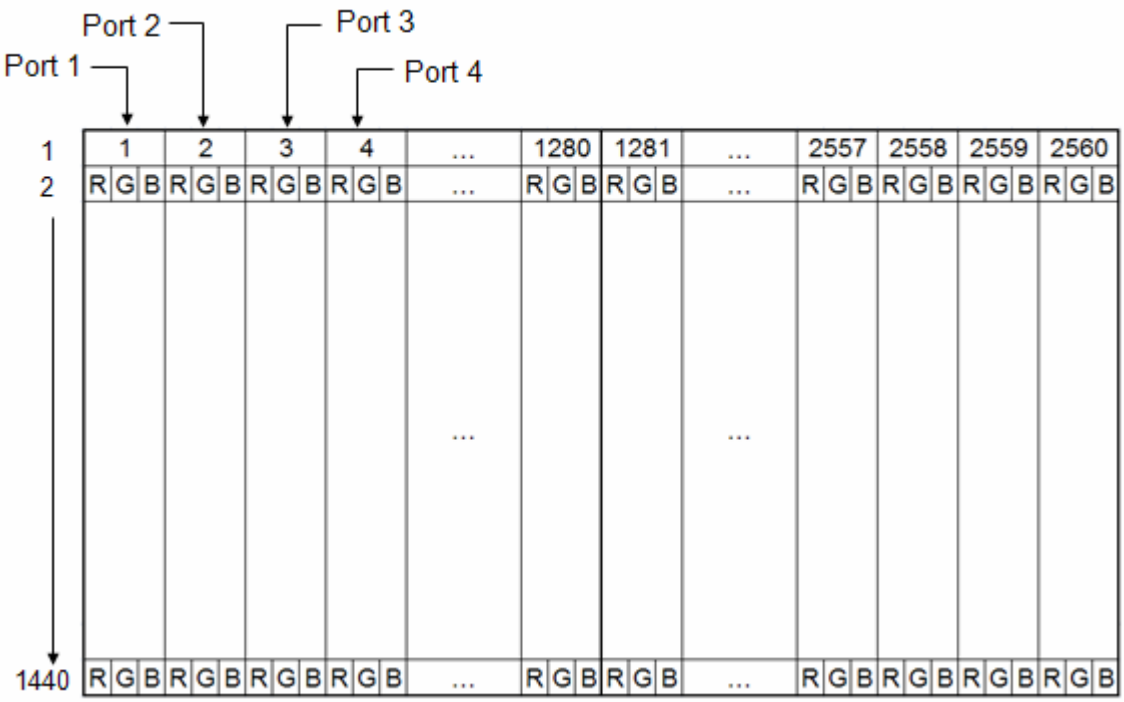


The duration of VDD rising time: 470us.

3.4 Signal Characteristics

3.4.1 LCD Pixel Format

Following figure shows the relationship between the input signals and LCD pixel format.



Note 1: The module use 4port-LVDS interface.

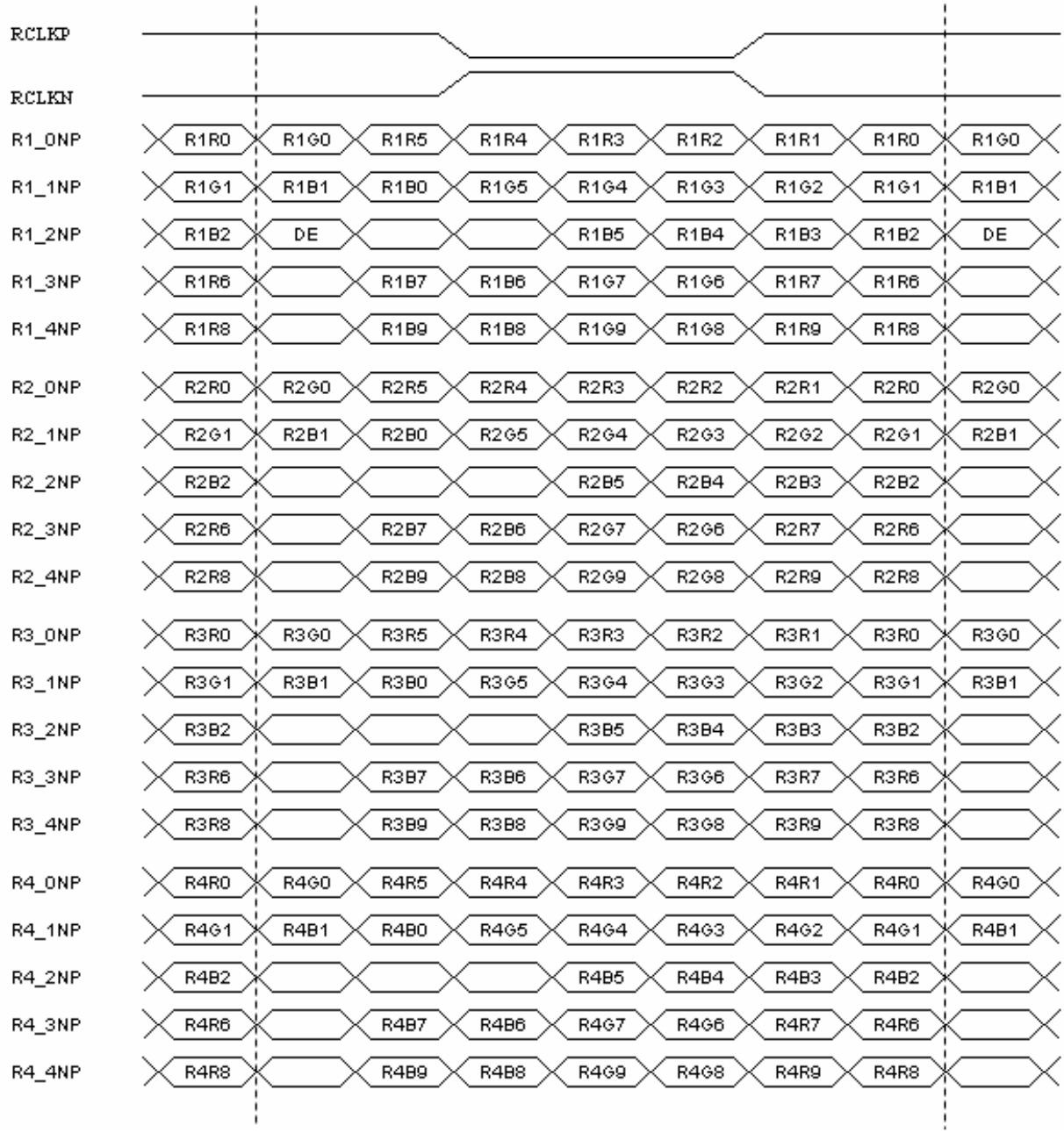
Port 1：1, 5……..→2557pixel

Port 2：2, 6……..→2558pixel

Port 3：3, 7……..→2559 pixel

Port 4：4, 8……..→2560 pixel

3.4.2 LVDS Data Format



3.4.3 Color versus Input Data

The following table is for color versus input data (10bit). The higher the gray level, the brighter the color.

Color	Gary Level	Color Input Data																												Remark
		RED data (MSB:R9,LSB:R0)										GREEN data (MSB:G9,LSB:G0)										BLUE data (MSB:B9,LSB:B0)										
		R9	R8	R7	R6	R5	R4	R3	R2	R1	R0	G9	G8	G7	G6	G5	G4	G3	G2	G1	G0	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0	
Black	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
L511	-	0	1	1	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	1	1	
Red	L0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L1023	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
Green	L0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L1023	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	
Blue	L0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L1023	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	

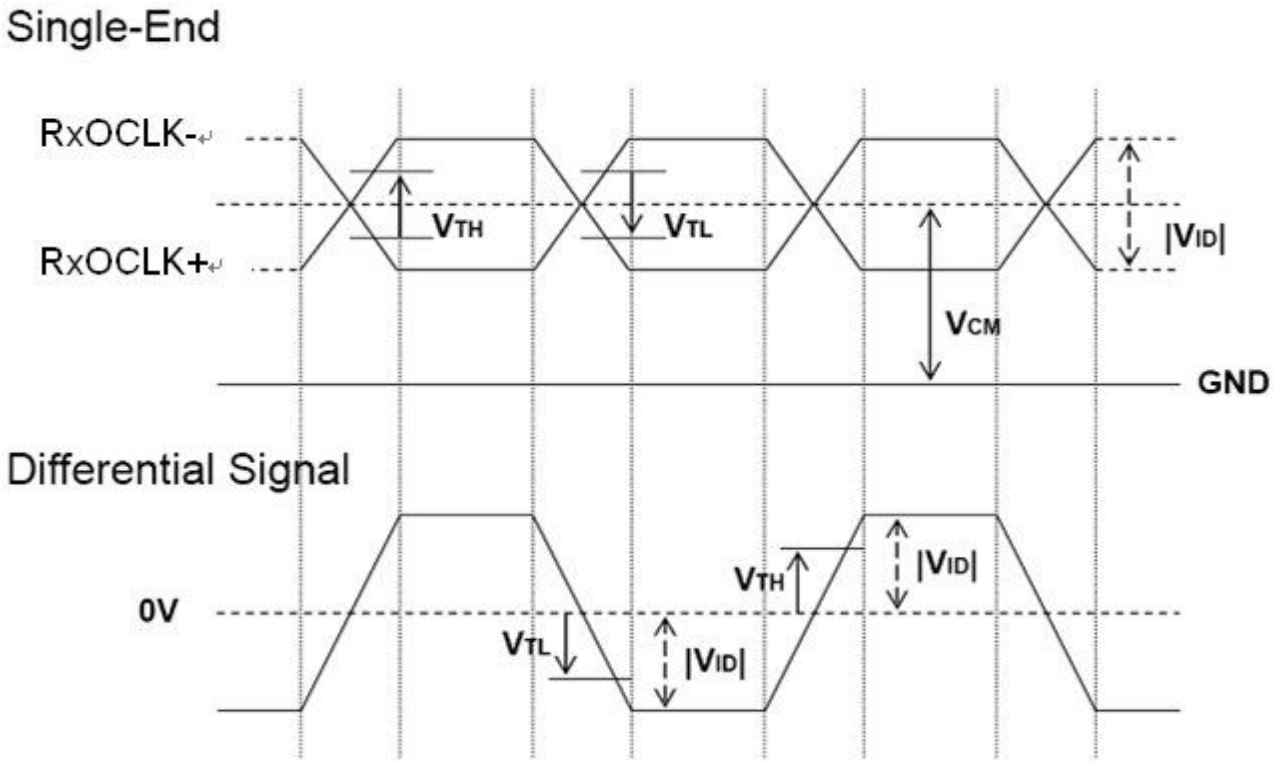
3.4.4 LVDS Specification

a. DC Characteristics:

Symbol	Description	Min	Typ	Max	Units	Condition
V_{TH}	LVDS Differential Input High Threshold	-	-	+100	[mV]	V_{CM} = 1.2V
V_{TL}	LVDS Differential Input Low Threshold	-100	-	-	[mV]	V_{CM} = 1.2V
$\lvert V_{ID} \rvert$	LVDS Differential Input Voltage	100	-	600	[mV]	
V_{CM}	LVDS Common Mode Voltage	+1.0	+1.2	+1.5	[V]	V_{TH}-V_{TL} = 200mV

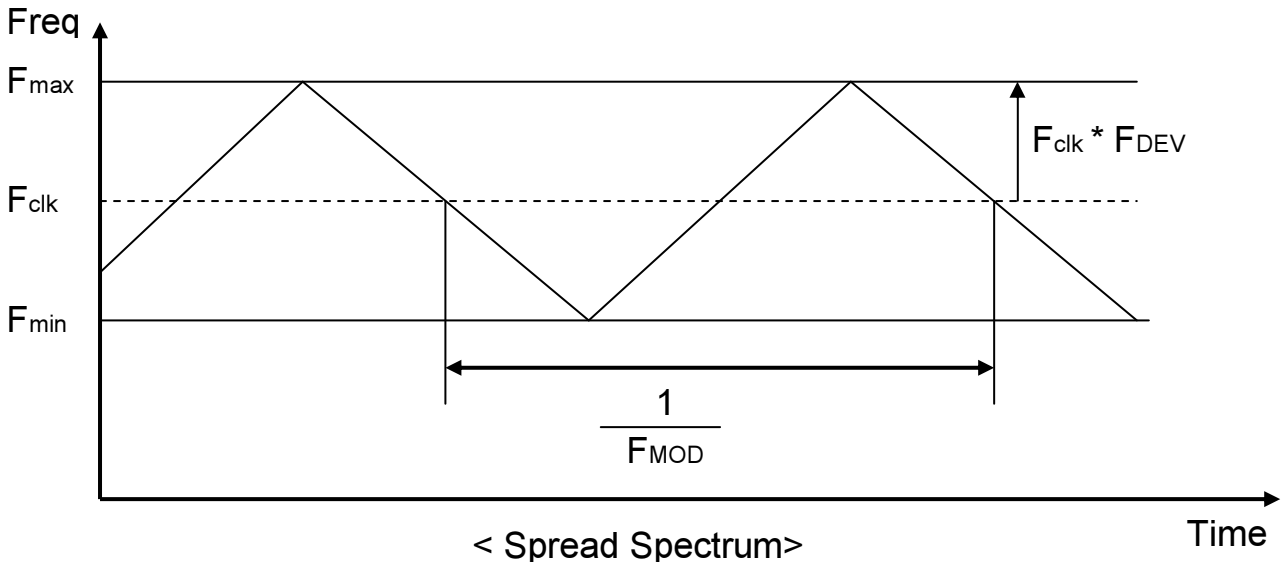
LVDS Signal Waveform:

Use RxOCLK- & RxOCLK+ as example.



b. AC Characteristics:

Symbol	Description	Min	Max	Unit	Remark
F_{DEV}	Maximum deviation of input clock frequency during Spread Spectrum	-	± 3	%	
F_{MOD}	Maximum modulation frequency of input clock during Spread Spectrum	-	200	KHz	



< Spread Spectrum>

Fclk: LVDS Clock Frequency

3.4.5 Input Timing Specification

It only support DE mode, and the input timing are shown as the following table.

Symbol	Description		Min.	Typ.	Max.	Unit	Remark
Tv	Vertical Section	Period	1479	1481	1483	Th	
Tdisp (v)		Active	1440	1440	1440	Th	
Tblk (v)		Blanking	39	41	43	Th	
Fv		Frequency	50	60	75	Hz	
Th	Horizontal Section	Period	676	680	684	Tclk	
Tdisp (h)		Active	640	640	640	Tclk	
Tblk (h)		Blanking	36	40	44	Tclk	
Fh		Frequency	73.9	88.8	111.2	KHz	***Note 3-3***
Tclk	LVDS Clock	Period	22.22	16.56	13.16	ns	1/Fclk
Fclk		Frequency	45	60.4	76	MHz	***Note 3-4***

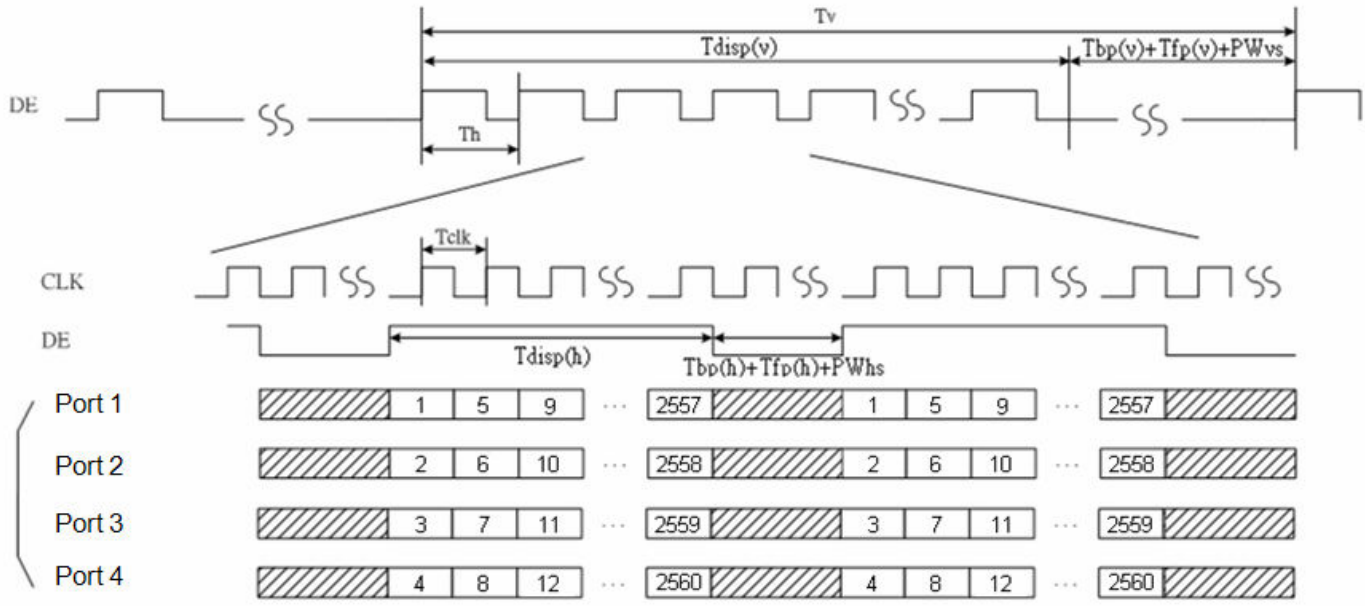
Note 3-3: The equation is listed as following. Please don't exceed the above recommended value.

Fh (Min.) = Fclk (Min.) / Th (Min.);
Fh (Typ.) = Fclk (Typ.) / Th (Typ.);
Fh (Max.)= Fclk (Max.) / Th (Min.);

Note 3-4: The equation is listed as following. Please don't exceed the above recommended value.

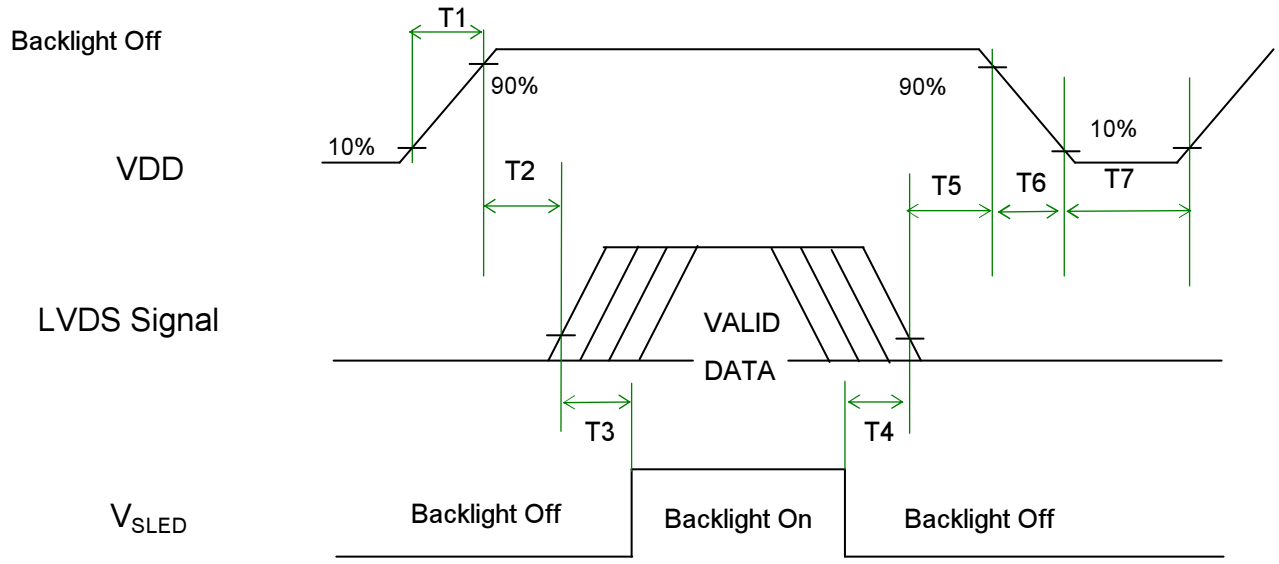
Fclk (Min.) = Fv (Min.) x Th (Min.) x Tv (Min.);
Fclk (Typ.) = Fv (Typ.) x Th (Typ.) x Tv (Typ.);
Fclk (Max.) = Fv (Max.) x Th (Typ.) x Tv (Typ.);

3.4.6 Input Timing Diagram



3.5 Power ON/OFF Sequence

VDD power,LVDS signal and backlight on/off sequence are as following. LVDS signals from any system shall be Hi-Z state when VDD is off.



Power Sequence Timing

Symbol	Value			Unit	Remark
	Min.	Typ.	Max.		
T1	0.5	-	10	[ms]	
T2	0	-	50	[ms]	
T3	500	-	-	[ms]	
T4	100	-	-	[ms]	
T5	0		50	[ms]	***Note 3-5*** ***Note 3-6***
T6	0	-	150	[ms]	***Note 3-6***
T7	1000	-	-	[ms]	

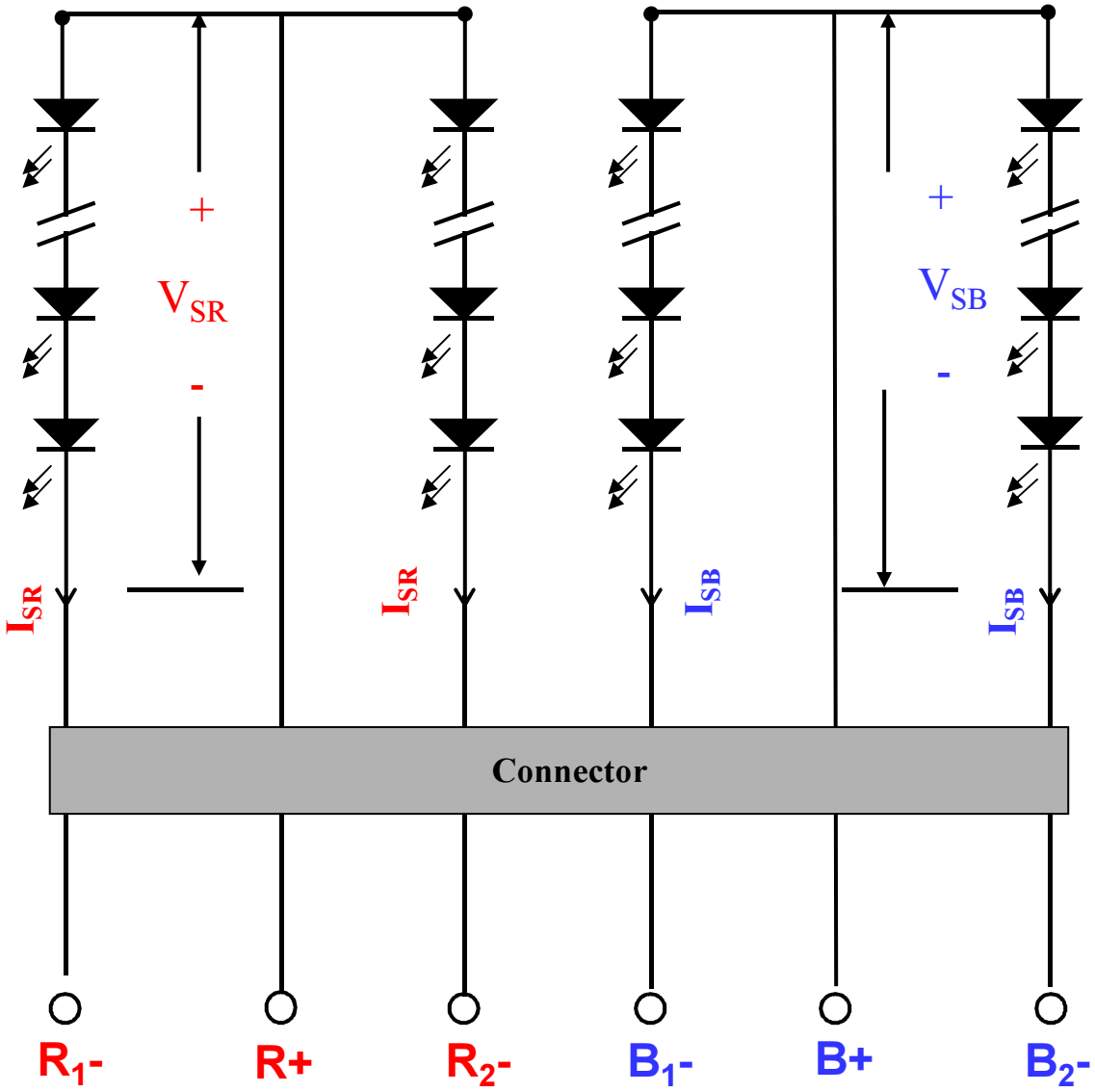
Note 3-5 : Recommend setting T5 = 0ms to avoid electronic noise when VDD is off.

Note 3-6 : During T5 and T6 period , please keep the level of input LVDS signals with Hi-Z state.

4 Backlight Unit

4.1 Block Diagram

The following shows the block diagram of the 27.0 inch Backlight Unit. And it includes 2 pcs LED light bar in Backlight Unit. Each LED light bar includes 30 pcs LED package. (2 strings RED LED chip & 2 strings Blue LED chip in one LED light bar, and 15 pcs LED in one string).



4.2 Interface Connection

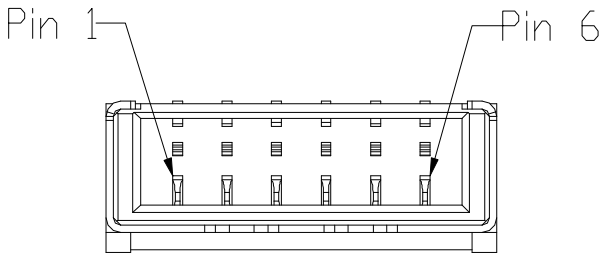
4.2.1 Connector Type

Backlight Connector	Manufacturer	ENTERY
	Part Number	3707K-S06N-21R
Mating Connector	Manufacturer	ENTERY
	Part Number	H112K-P06N-00B (Non-Locking type) H112K-P06N-03B (Locking type)

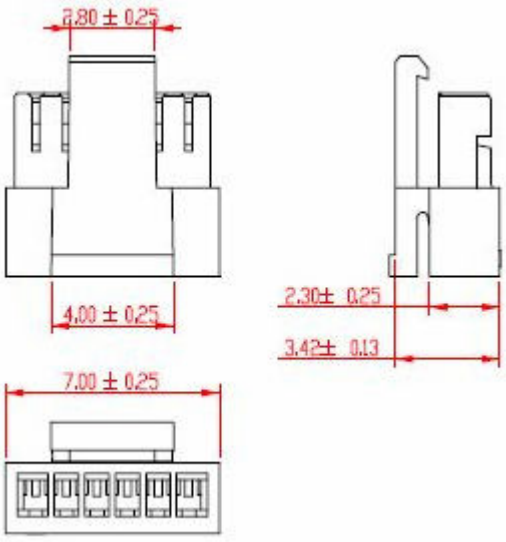
Backlight Connector dimension:

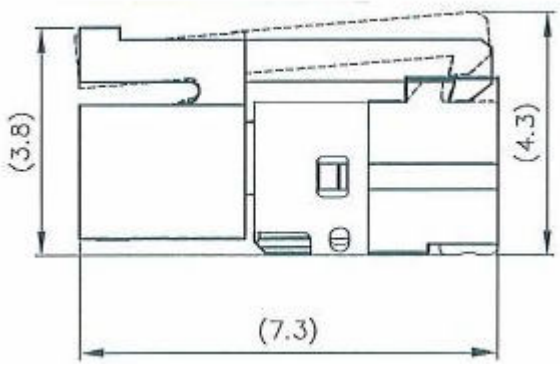
Connector

3707K-S06N-21R



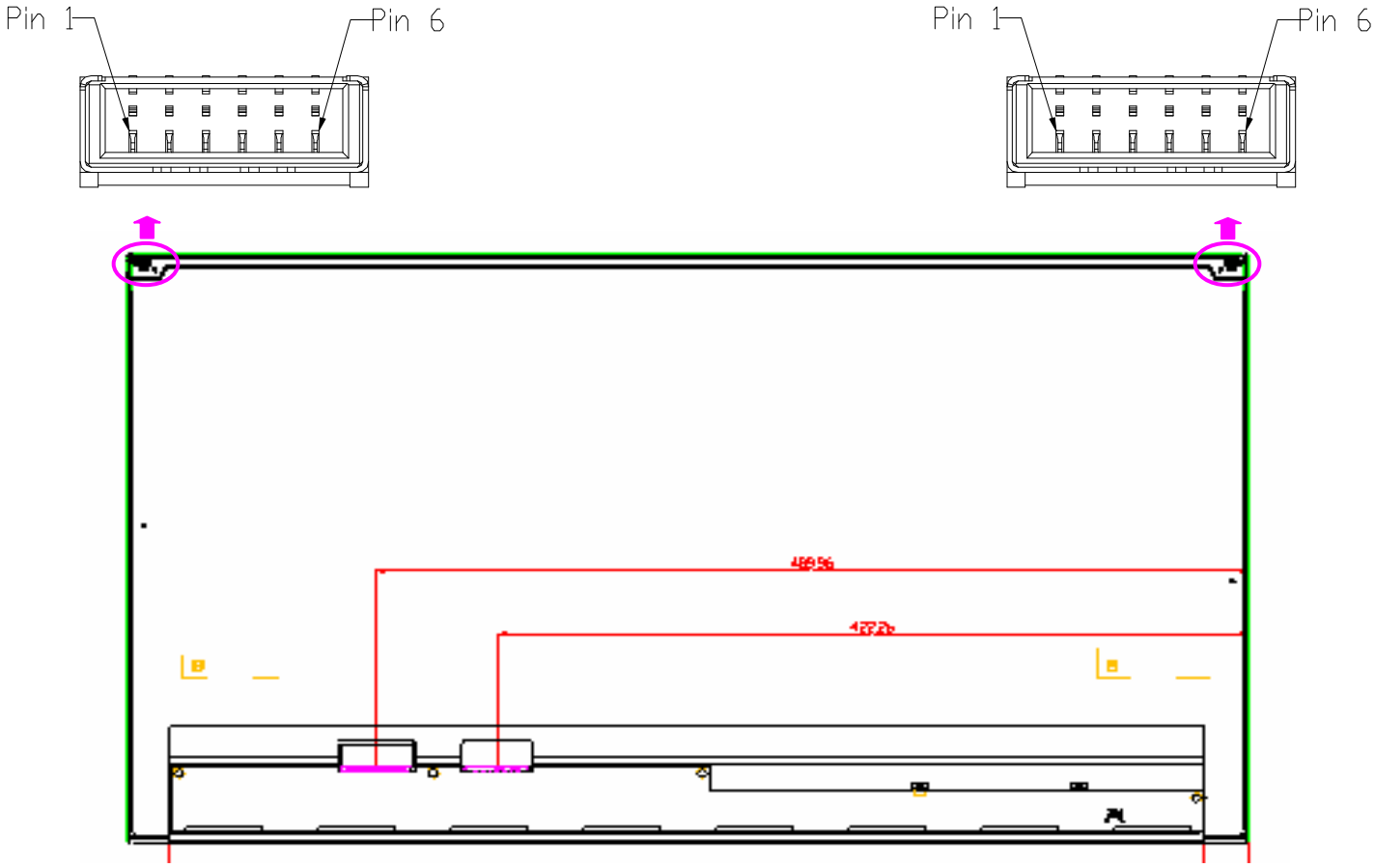
Mating Connector dimension:





4.2.2 Connector Pin Assignment

Pin#	Symbol	Description	Remark
1	R_1 -	Red LED Channel 1 Cathode	
2	R +	Red LED Common Anode	
3	R_2 -	Red LED Channel 2 Cathode	
4	B_1 -	Blue LED Channel 1 Cathode	
5	B +	Blue LED Common Anode	
6	B_2 -	Blue LED Channel 2 Cathode	



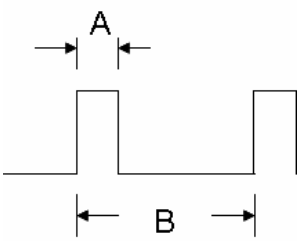
4.3 Electrical Characteristics

4.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

(Ta=25℃)

Symbol	Description	Min	Max	Unit	Remark
Is_R	LED String Current	0	100	[mA]	100% duty ratio
Is_B	LED String Current	0	160	[mA]	100% duty ratio



Duty ratio= (A / B) X 100% ; (A: Pulse time, B: Period)

4.3.2 Recommended Operating Condition

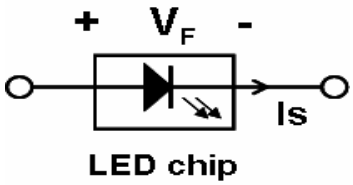
(Ta=25℃)

Symbol	Description	Min.	Typ.	Max.	Unit	Remark
Is_R	R_LED String Current	-	65.0	71.5	[mA]	100% duty ratio of LED chip
Is_B	B_LED String Current	-	100.0	110.0	[mA]	100% duty ratio of LED chip
Vs_R	R_LED String Voltage	31.5	36.0	39.0	[Volt]	Is_R=65mA @ 100% duty ratio; ***Note 4-1***
Vs_B	B_LED String Voltage	42	46.5	51.0	[Volt]	Is_B=100mA @ 100% duty ratio; ***Note 4-1***
ΔVs_R	Maximum ΔVs_R Voltage Deviation of light bar	-	-	3.0	[Volt]	Is_R=65mA @ 100% duty ratio; ***Note 4-2***
ΔVs_B	Maximum ΔVs_B Voltage Deviation of light bar	-	-	3.0	[Volt]	Is_B=100mA @ 100% duty ratio; ***Note 4-2***
P_{BLU}	LED Light Bar Power Consumption	-	27.9	33.5	[Watt]	***Note 4-3***
LT_{LED}	LED Life Time	30,000	-	-	[Hour]	***Note 4-4***

Note 4-1: Vs (Typ.) = V_F (Typ.) X LED No. (one string);

a. V_F: LED chip forward voltage, Blue LED V_F (Min.)=2.8V, V_F(Typ.)=3.1V, V_F(Max.)=3.4V; Red LED V_F (Min.)=2.1V, V_F(Typ.)=2.4V, V_F(Max.)=2.6V

b. The same euqation to calculate Vs(Min.) & Vs (Max.) for respective V_F (Min.) & V_F(Max.);



Note 4-2: ΔVs (Max.) = ΔV_F X LED No. (one string);

a. ΔV_F: LED chip forward voltage deviation; (0.2 V , each Bin of LED V_F)

Note 4-3: P_{BLU} (Typ.) = [Vs_R (Typ.) X Is_R (Typ.) + Vs_B (Typ.) X Is_B (Typ.)] X 2 X 2 ;

(“2” is total Red (or Blue) String No. of single LED Light bar.

“2” is total LED Light bar No. of single Backlight Unit.)

P_{BLU} (Max.) = [Vs_R (Max.) X Is_R (Max.) + Vs_B (Max.) X Is_B (Max.)] X 2 X 2

Note 4-4: Definition of life time:

a. Brightness of LED becomes to 50% of its original value

b. Test condition: Is_R = 65mA, Is_B = 100mA and 25℃ (Room Temperature)

5 Reliability Test

AUO reliability test items are listed as following table. (*Bare Panel only*)

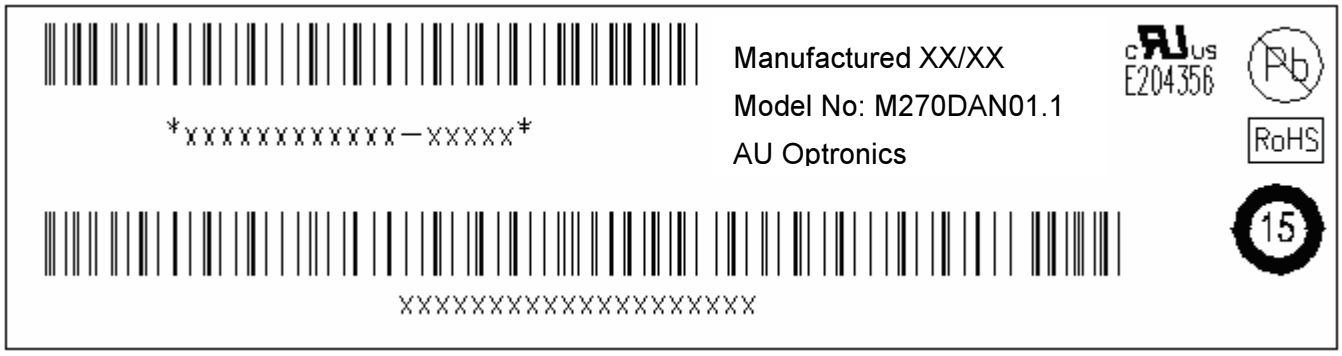
Items	Condition	Remark
Temperature Humidity Bias (THB)	Ta= 50℃, 80%RH, 300hours	
High Temperature Operation (HTO)	Ta= 50℃, 50%RH, 300hours	
Low Temperature Operation (LTO)	Ta= 0℃, 300hours	
High Temperature Storage (HTS)	Ta= 60℃, 300hours	
Low Temperature Storage (LTS)	Ta= -20℃, 300hours	
Vibration Test (Non-operation)	Acceleration: 1.5 Grms Wave: Random Frequency: 10 - 200 Hz Sweep: 30 Minutes each Axis (X, Y, Z)	
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 20 ms Direction: ±X, ±Y, ±Z (one time for each Axis)	
Drop Test	Height: 45.6 cm, package test	
Thermal Shock Test (TST)	-20℃/30min, 60℃/30min, 100 cycles	***Note 5-1***
On/Off Test	On/10sec, Off/10sec, 30,000 cycles	
ESD (Electro Static Discharge)	Contact Discharge: ± 15KV, 150pF(330Ω) 1sec, 8 points, 25 times/ point.	***Note 5-2***
	Air Discharge: ± 15KV, 150pF(330Ω) 1sec 8 points, 25 times/ point.	
Altitude Test	Operation:18,000 ft Non-Operation:40,000 ft	

Note 5-1: a. A cycle of rapid temperature change consists of varying the temperature from -20℃ to 60℃, and back again. Power is not applied during the test.
b. After finish temperature cycling, the unit is placed in normal room ambient for at least 4 hours before power on.

Note 5-2: EN61000-4-2, ESD class B: Certain performance degradation allowed
No data lost
Self-recoverable
No hardware failures.

6 Shipping Label

The label is on the panel as shown below:



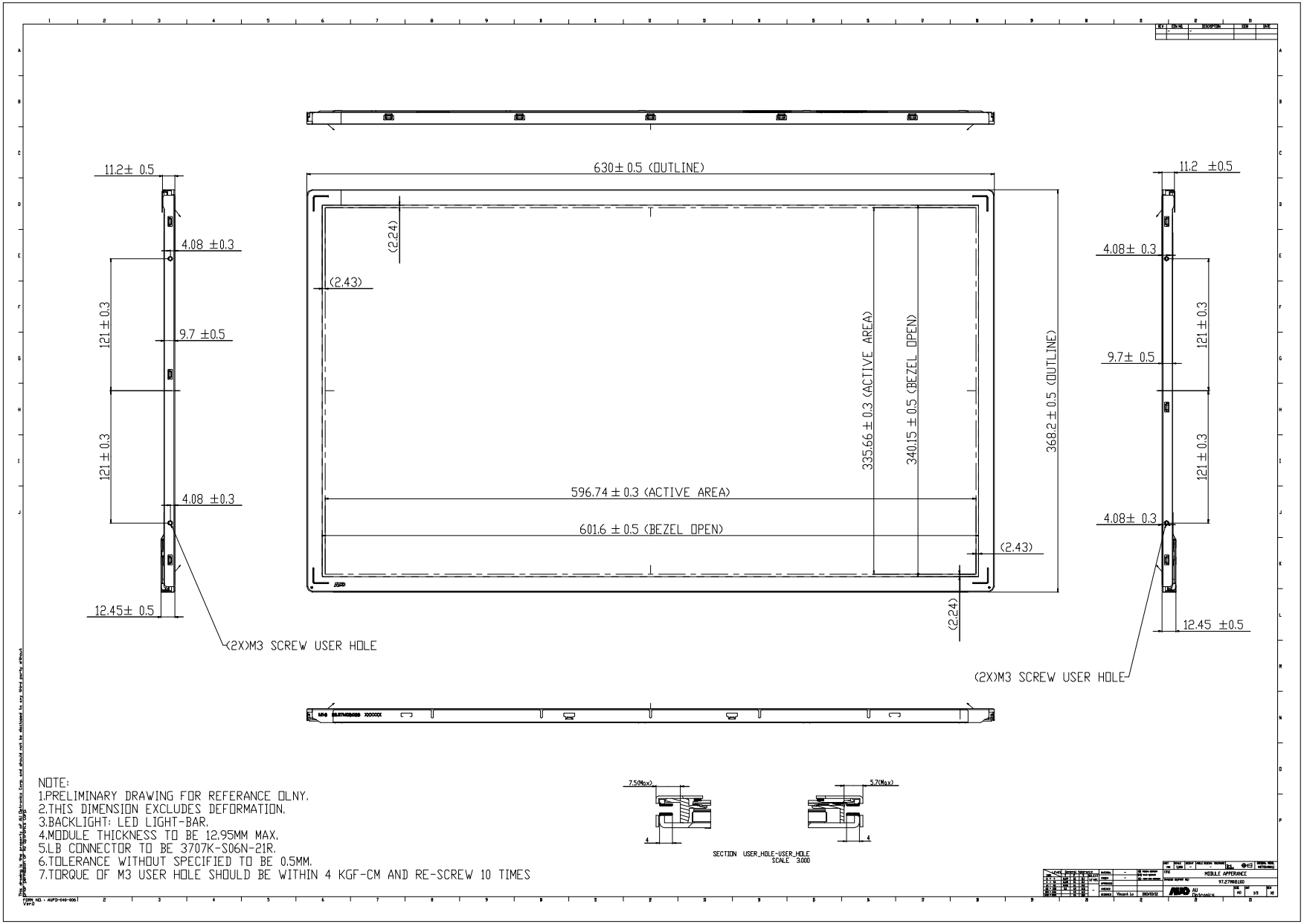
Note 6-1: For Pb Free products, AUO will add for identification.

Note 6-2: For RoHS compatible products, AUO will add for identification.

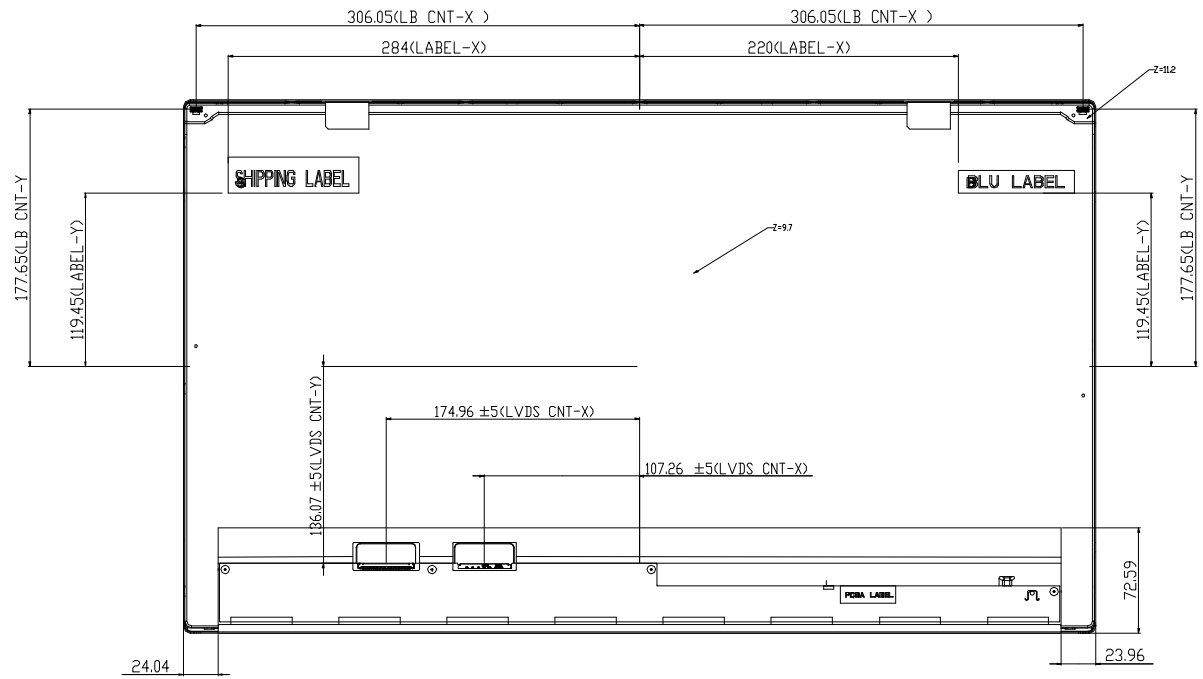
Note 6-3: For China RoHS compatible products, AUO will add for identification.

Note 6-4: The Green Mark will be presented only when the green documents have been ready by AUO Internal Green Team.

7 Mechanical Characteristics

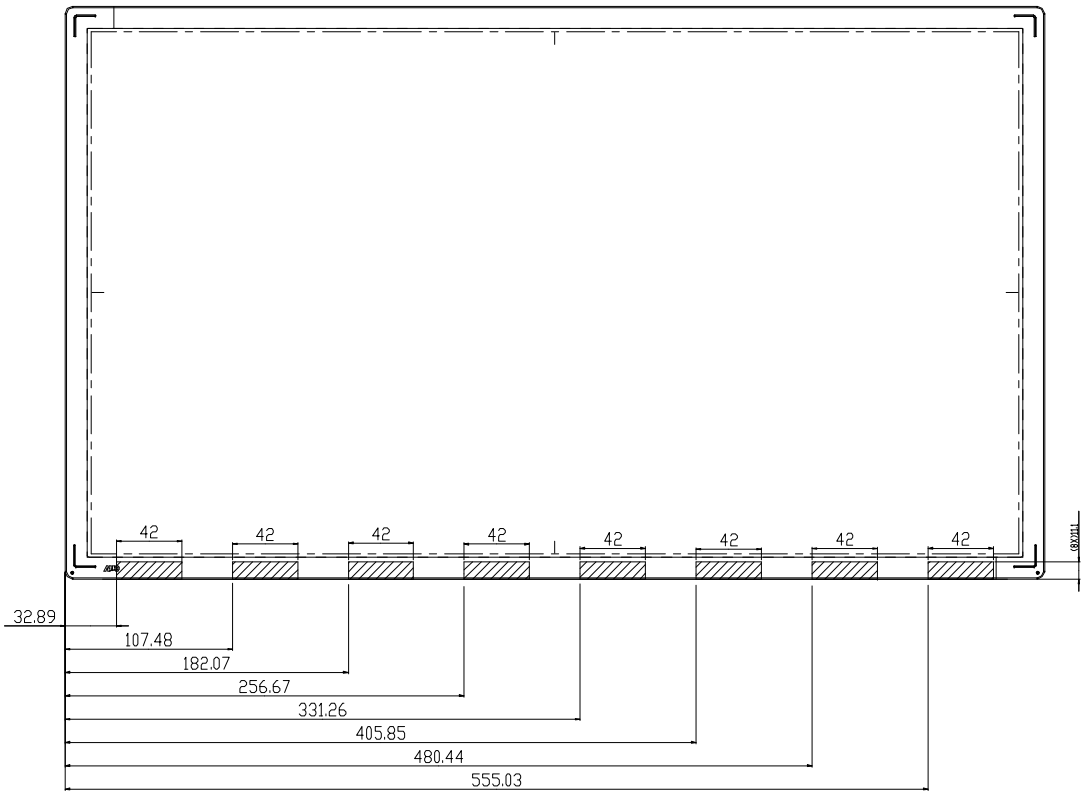


NOTES :
1. THE DIMENSION EXCLUDES DEFORMATION.
2. TOLERANCE WITHOUT NOTICED TO BE ` 0.5MM.



Avoid Touching COF Position When Doing Mechanical Design

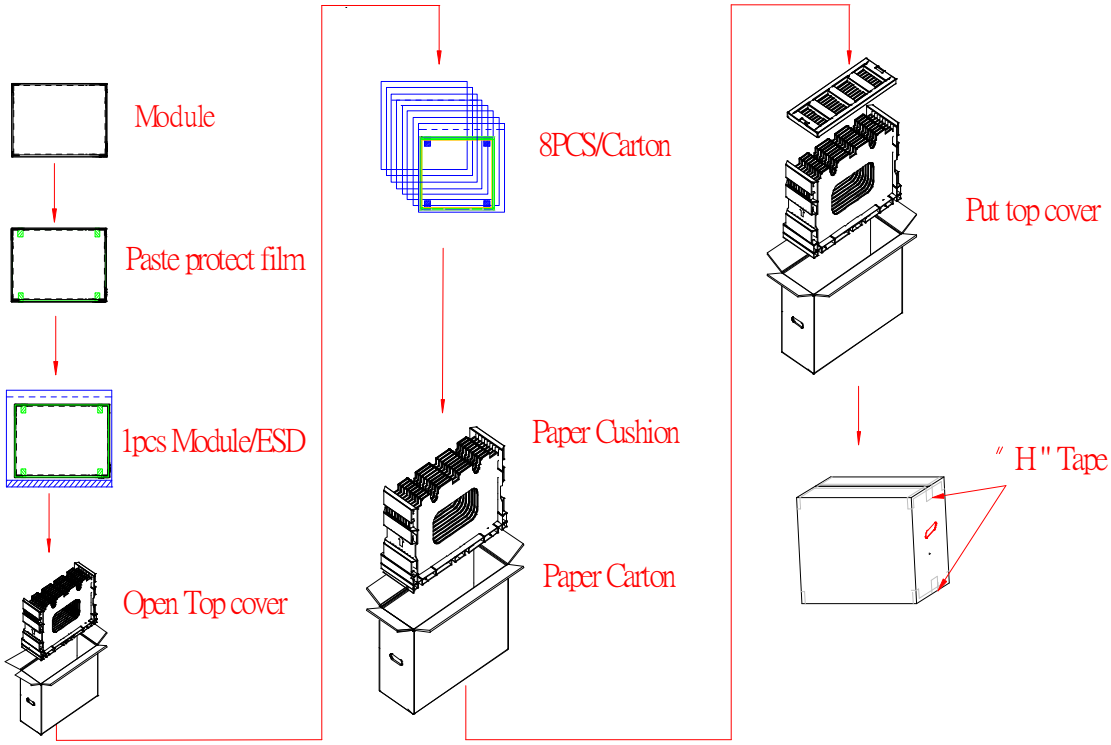
NOTES :
1. THE DIMENSION EXCLUDES DEFORMATION.
2. TOLERANCE WITHOUT NOTICED TO BE ± 0.5MM.

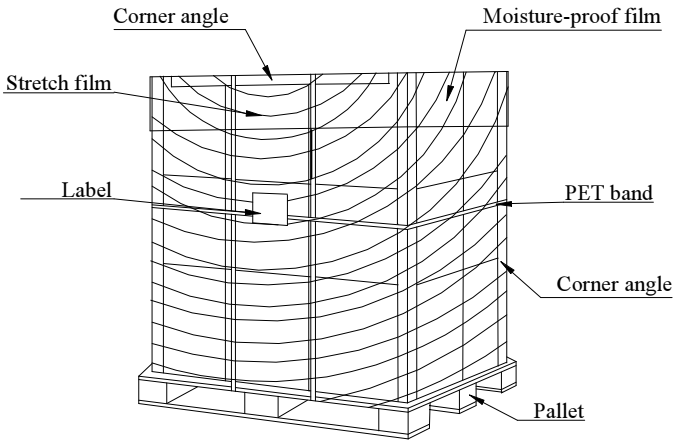


Avoid touching COF position when doing mechanical design

8 Packing Specification

8.1 Packing Flow





8.2 Pallet and shipment information

Item	Specification			Remark
	Q'ty	Dimension	Weight(kg)	
Panel	1	630(H)mm x 368.2(V)mm x 12.45(D)mm	3.05	
Cushion	1	-	3.62	
Box	1	720(L)mm x 264(W)mm x 460(H)mm	1.25	without Panel & cushion
Packing Box	8 pcs/Box	720(L)mm x 264(W)mm x 460(H)mm	29.27	with panel & cushion
Pallet	1	1070(L)mm x 740(W)mm x 138(H)mm	12.9	
Pallet after Packing	8 boxes/pallet	1070(L)mm x 740(W)mm x 1060(H)mm	247.06	